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STANDA MILIT DRAV	AR VIN	Y G			CHE CHE	PROV	ED B	MICROCIRCUIT, DIGITAL, BIPOLAR, LOW POWER SCHOTTKY TTL, OCTAL BUS TRANCEIVERS, OPEN COLLECTOR OUTPUTS, MONOLITHIC SILICON				IER PEN											
THIS DRAWING FOR USE BY AL AND AGENG DEPARTMENT AMSC N/A	DEF	PARTI	HEN'	TS	15	DRAWING APPROVAL DATE 15 JUNE 1990 REVISION LEVEL SIZE CAGE CODE A 67268 SHEET 1				-89	974	18											

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 $\,$ = U.S. Government printing office: 1987 — 748-129/60911 $\,5962 - E1640\,$

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

1. SCOPE				
1.1 Scope. This drawing describes deviwith 1.2.1 of MIL-STD-883, "Provisions for non-JAN devices".	ice requir r the use	ements for c of MIL-STD-8	lass B micro 83 in conjun	circuits in accordance ction with compliant
1.2 Part number. The complete part num	mber shall	be as shown	in the foll	owing example:
5962-89748 01	l type	R 	Tine	X T
	2.1)	(1.2.2		MIL-M-38510
1.2.1 <u>Device type</u> . The device type sha	all identi	fy the circu	it function	as follows:
Device type Generic number		Circu	it function	
01 54LS642 Oct	tal bus tr	ansceivers w	ith invertin	g, open collector outputs
1.2.2 <u>Case outline</u> . The case outline s follows:	shall be a	s designated	in appendix	. C of MIL-M-38510, and as
Outline letter		Case outline		
R D-8 (20-lead, S F-9 (20-lead, 2 C-2 (20-termin	1.060" x .540" x . nal, .358"	.310" x .200 300" x .100" x .358" x .	"), dual-in-), flat pack 100"), squar	line package age e chip carrier package
1.3 Absolute maximum ratings.				
Supply voltage range V _{CC} DC input voltage: All inputs and I _J Storage temperature range Maximum power dissipation (P _D) 1/Lead temperature (soldering, 10 sec Thermal resistance, junction-to-cas Junction temperature (T _J)	/0 ports - :onds) se (0.10) -		-1.5 V dc a -65°C to +1 522.5 mW +300°C	0 +7.0 V dc t -18 mA to +7.0 V dc 50°C 8510, appendix C
1.4 Recommended operating conditions.				
Supply voltage range (V _{CC}) Minimum high-level input voltage (V _{Maximum} low-level input voltage (V _{Maximum} high-level output voltage (Maximum input clamp current (I _{IC}) Maximum low-level output current (I _{IC}) Case operating temperature range (T	(OH) (F) (IH)		2.0 V dc 0.5 V dc	
1/ Maximum power dissipation is defined a	as V _{CC} × I	cc•		
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2. APPLICABLE DOCUMENTS

2.1 Government specification, standard, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

BULLETIN

MILITARY

MIL-BUL-103 - List of Standard Military Drawings (SMD's).

(Copies of the specification, standard, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
 - 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.2 Truth table. The truth table shall be as specified on figure 2.
- 3.2.3 Test circuit and switching waveforms. The test circuit and switching waveforms shall be as specified on figure 3.
 - 3.2.4 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.
- 3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

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TABLE I. Electrical performance characteristics. Conditions $-55^{\circ}\text{C} < T_{\text{C}} < +125^{\circ}\text{C}$ unless otherwise specified Limits Unit Group A Test Symbol subgroups Min Max ٧ V_{CC} = 4.5 V A or B input 1,2,3 0.1 HYST Hysteresis $(V_{T+} - V_{T-})$ V_{CC} = 4.5 V, V_{IH} = 2 V, V_{IL} = 0.5 V mΑ 0.1 $V_{OH} = 5.5 V$, 1,2,3 High level output | I OH current V_{CC} = 4.5 V, V_{IH} = 2.0 V, V_{IL} = 0.5 V 0.4 ٧ $I_{OL} = 12 \text{ mA}$ 1,2,3 Low level output VOL voltage -1.5 $V_{CC} = 4.5 \text{ V}$ $I_{IN} = -18 \text{ mA}$ 1,2,3 Input clamp voltage A IC | VIN = 5.5 V 1,2,3 100 μΑ V_{CC} = 5.5 V | A or B High level input I_{IH1} current 1100 DIR or \overline{G} $V_{IN} = 7.0 V$ 20 | VIN = 2.7 V I_{IH2} -0.4 1,2,3 mΑ $V_{CC} = 5.5 \text{ V}, V_{IN} = 0.4 \text{ V}$ Low level input $|I_{IL}|$ current 1,2,3 70 mΑ Outputs high $|V_{CC} = 5.5 \text{ V}$ Supply current ICCH Outputs open 90 Outputs low ICCL 95 Outputs disabled ICCZ 7,8 See 4.3.1c Functional tests See footnotes at end of table. SIZE **STANDARDIZED** Α 5962-89748 **MILITARY DRAWING** REVISION LEVEL SHEET DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444 4

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Test	Symbol	Conditions	Group A	Lim	Unit	
		$-55^{\circ}C \le T_{C} \le +125^{\circ}C$ unless otherwise specified	subgroups	Min	Max	<u> </u>
Propagation delay time A to B	t _{PLH1}	V _{CC} = 5.0 V, <u>2</u> / C _L = 50 pF,	9,10,11	1	35	ns
Propagation delay time B to A		R_ = 6670, See figure 3		1	35	
Propagation delay time A to B	t _{PHL1}		9,10,11	1	35	l ns
Propagation delay time B to A	 	 <u> </u>	 	1	35	
Output disable time G, DIR to A	t _{PLH2}	T 	9,10,11	1	56	l I ns
Output disable time G, DIR to B			† 	1	 56 	
Output enable time G, DIR to A	t _{PHL2}	T 	9,10,11	1	84	l ns
Output enable time G, DIR to B	 			1	84	

- 1/ This parameter is guaranteed, but not tested.
- $^{2}/$ Testing may be performed using either C_L = 45 pF or C_L = 50 pF; however, the manufacturer shall certify that the microcircuits meet the switching test limits specified for a 50 pF load.
- $3.5\,$ Marking. Marking shall be in accordance with MIL-STD-883 (see $3.1\,$ herein). The part shall be marked with the part number listed in $1.2\,$ herein. In addition, the manufacturer's part number may also be marked as listed in MIL-BUL-103 (see $6.6\,$ herein).
- 3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-ECC prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.7 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 Notification of change. Notification of change to DESC-ECC shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.9 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

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Ten	ninal connections						
Terminal	Device 01						
number	Cases						
	R, S, and 2						
1	DIR						
2	A1						
1 2 3 4 5 6 7	A2 A3						
5	A4						
6	A5						
7 8	A6						
9	A7 A8						
10	GND						
11	B8						
12	B7						
13 14	B6 B5						
15	I B4						
16	64 B3						
17	B2						
18	j B1						
19 20	। ढ ! ^v cc						
	"((

NC = No connection

FIGURE 1. Terminal connections.

Control inputs	Operation
G DIR	
L L L H H X	B data to A bus A data to B bus Isolation

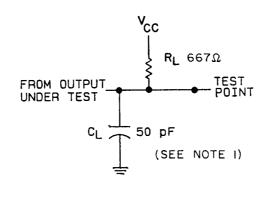
H = High level voltage
L = Low level voltage
X = Irrelevant

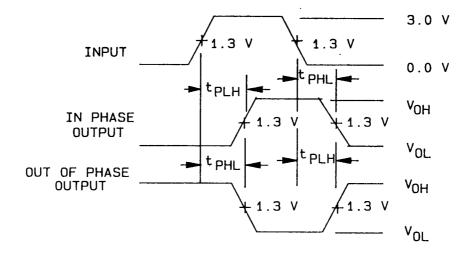
FIGURE 2. Truth table.

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NOTES:

1. $C_{\rm L}$ includes probe and jig capacitance. 2. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_{\rm OUT}$ approximately 50 ohms, $t_{\rm r} \leq$ 15 ns, $t_{\rm f} \leq$ 6 ns.

FIGURE 3. Test circuit and switching waveforms.

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- 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - c. Subgroup 7 and 8 tests shall verify the truth table as specified on figure 2.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	
	1*, 2, 3, 7, 8, 9, 10**, 11**
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10**, 11**
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

* PDA applies to subgroup 1.

** Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.4 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-ECS, telephone (513) 296-6022.
- 6.5 Comments. Comments on this drawing should be directed to DESC-ECC, Dayton, Ohio 45444, or telephone 513-296-8525.

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6.6 Approved source of supply. An approved source of supply is listed in MIL-BUL-103. Additional sources will be added to MIL-BUL-103 as they become available. The vendor listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECS. The approved source of supply listed below is for information purposes only and is current only to the date of the last action of this document.

Military drawing part number 	Vendor CAGE number	Vendor similar part number <u>1</u> /
5962-8974801RX	01295	SNJ54LS642J
5962-8974801SX	01295	SNJ 54LS642W
5962-89748012X	01295	SNJ54LS642FK

 $\frac{1}{I \text{ tems acquired to this number for item acquisition.}}$ $\frac{1}{I \text{ tems acquired to this number may not satisfy the performance requirements of this drawing.}}$

Vendor CAGE number

01295

Vendor name and address

Texas Instruments, Incorporated 13500 N. Central Expressway P.O. Box 655303 Dallas, TX 75265

Point of contact: I-20 at FM 1788

Midland, TX 79711-0448

STANDARDIZED
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DEFENSE ELECTRONICS SUPPLY CENTER

DAYTON, OHIO 45444

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